#### INTEGRATED CIRCUITS

## DATA SHEET

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

# TDA1517; TDA1517P 2 x 6 W stereo power amplifier

Product specification Supersedes data of 2002 Jan 17

2004 Feb 18





## 2 x 6 W stereo power amplifier

## TDA1517; TDA1517P

#### **FEATURES**

- · Requires very few external components
- · High output power
- · Fixed gain
- · Good ripple rejection
- · Mute/standby switch
- AC and DC short-circuit safe to ground and V<sub>P</sub>
- · Thermally protected
- · Reverse polarity safe
- Capability to handle high energy on outputs (V<sub>P</sub> = 0 V)
- · No switch-on/switch-off plop
- Electrostatic discharge protection.

#### **GENERAL DESCRIPTION**

The TDA1517 is an integrated class-B dual output amplifier in a plastic single in-line medium power package with fin (SIL9MPF), a plastic rectangular-bent single in-line medium power package with fin (RBS9MPF) or a plastic heat-dissipating dual in-line package (HDIP18). The device is primarily developed for multi-media applications.

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#### **QUICK REFERENCE DATA**

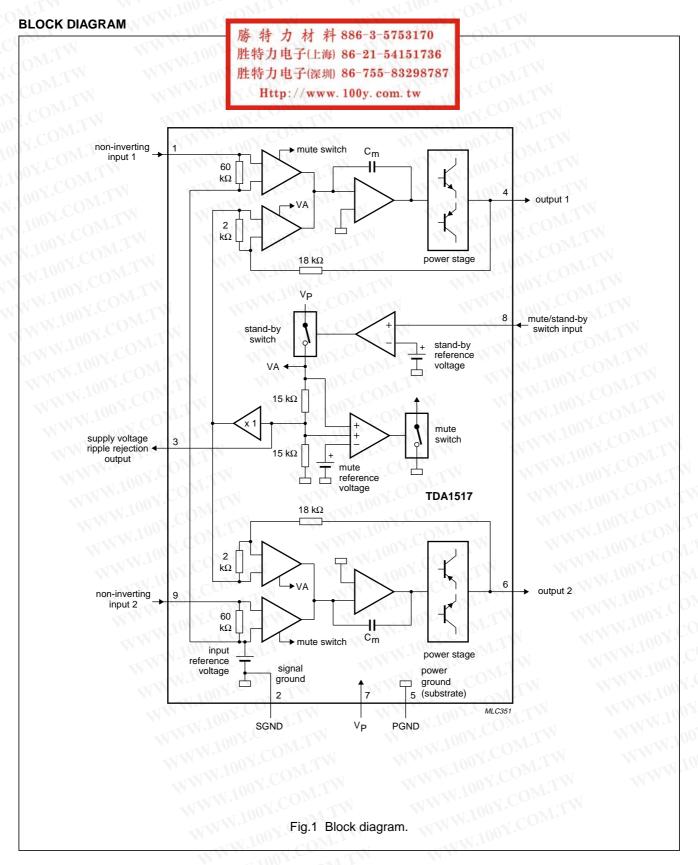
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>P</sub>	supply voltage	O. OM.TW	6.0	14.4	18.0	V
I <sub>ORM</sub>	repetitive peak output current	OY.CO.	- 1/1/1/1	-100	2.5	Α
I <sub>q(tot)</sub>	total quiescent current	ON CONTRACTO	- 111	40	80	mA
I <sub>sb</sub>	standby current	· CONT.	- 1	0.1	100	μΑ
I <sub>sw</sub>	switch-on current	(Too COM.	-	MAIN	40	μΑ
Z <sub>I</sub>	input impedance	11.1001. COM:11	50	-	100 2	kΩ
Po	output power	$R_L = 4 \Omega$ ; THD = 0.5%	_	5	POL	W
	. ON COME TW	$R_L = 4 \Omega$ ; THD = 10%	N -	6	-100X.	W
SVRR	supply voltage ripple rejection	f <sub>i</sub> = 100 Hz to 10 kHz	48	-WW	- 1007	dB
$\alpha_{cs}$	channel separation	MAN TAN COM.	40		17.	dB
G <sub>v</sub>	closed loop voltage gain	MAN TON	19	20	21	dB
V <sub>no(rms)</sub>	noise output voltage (RMS value)	W. TW. TOOL CON	17.	50	- W.10	μV
T <sub>c</sub>	crystal temperature	11001.00	TI	_	150	°C

#### ORDERING INFORMATION

TYPE NUMBER	MMMiron	PACKAGE	WW. 100X						
TYPE NUMBER	NAME	NAME DESCRIPTION							
TDA1517/N3	SIL9MPF	plastic single in-line medium power package with fin; 9 leads	SOT110-1						
TDA1517/N3/S5	RBS9MPF	plastic rectangular-bent single in-line medium power package with fin; 9 leads	SOT352-1						
TDA1517P	HDIP18	plastic heat-dissipating dual in-line package; 18 leads	SOT398-1						

## 2 x 6 W stereo power amplifier

## TDA1517; TDA1517P

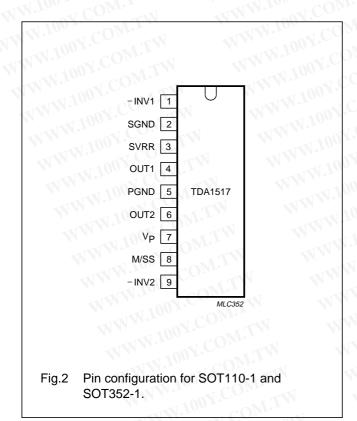


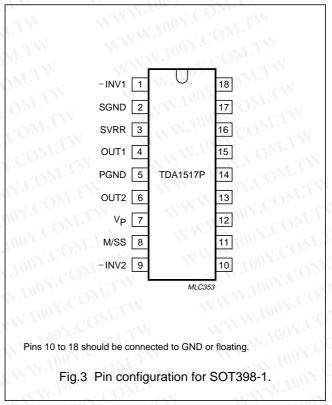
## 2 x 6 W stereo power amplifier

## TDA1517; TDA1517P

#### **PINNING**

SYMBOL	PIN	DESCRIPTION
-INV1	100 X · P	non-inverting input 1
SGND	2	signal ground
SVRR	3 CON	supply voltage ripple rejection output
OUT1	4 (0)	output 1
PGND	105	power ground
OUT2	6	output 2
V <sub>P</sub>	7,07.0	supply voltage
M/SS	8	mute/standby switch input
-INV2	9	non-inverting input 2





#### **FUNCTIONAL DESCRIPTION**

The TDA1517 contains two identical amplifiers with differential input stages. The gain of each amplifier is fixed at 20 dB. A special feature of the device is the mute/standby switch which has the following features:

- Low standby current (<100 μA)
- Low mute/standby switching current (low cost supply switch)
- Mute condition.

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## 2 x 6 W stereo power amplifier

TDA1517; TDA1517P

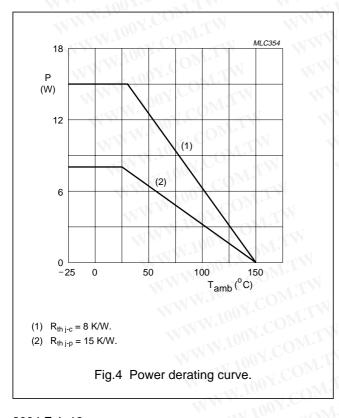
#### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>P</sub>	supply voltage	operating	OF - TW	18	V
	M. 100 1. COW. 1	no signal	$CO_{\overline{M}}$	20	V
V <sub>P(sc)</sub>	AC and DC short-circuit safe voltage	M. 100 x	COMI	18	V
V <sub>P(r)</sub>	reverse polarity	1777 1007	TIMO	6	V
ERGO	energy handling capability at outputs	$V_P = 0 V$	X.V-	200	mJ
I <sub>OSM</sub>	non-repetitive peak output current	TW WWW.	W.Co.	4	Α
I <sub>ORM</sub>	repetitive peak output current	MAN.T.	COM,	2.5	А
P <sub>tot</sub>	total power dissipation	see Fig.4	2 CO	15	W
T <sub>stg</sub>	storage temperature	WITH WITH	_55	+150	°C
T <sub>amb</sub>	operating ambient temperature	OM.TW	-40	+85	°C
T <sub>c</sub>	crystal temperature	in III	107.C	150	°C

#### THERMAL RESISTANCE

THERMAL R	ESISTANCE	N.100Y.COM.TW WWW.	100 A CON	I.TW
SYMBOL	TYPE NUMBER	PARAMETER	VALUE	UNIT
R <sub>th(j-c)</sub>	TDA1517/N3; TDA1517/N3/S5	thermal resistance from junction to case	8	K/W
R <sub>th(j-p)</sub>	TDA1517P	thermal resistance from junction to pins	15	K/W
R <sub>th(j-a)</sub>	TDA1517/N3; TDA1517/N3/S5; TDA1517P	thermal resistance from junction to ambient	50	C K/W



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## 2 x 6 W stereo power amplifier

TDA1517; TDA1517P

#### DC CHARACTERISTICS

V<sub>P</sub> = 14.4 V; T<sub>amb</sub> = 25 °C; measured in Fig.6; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply	MMM.road.COM.	TW WWW.100Y.CC	T	N	•	•
V <sub>P</sub>	supply voltage	note 1	6.0	14.4	18.0	V
I <sub>q(tot)</sub>	total quiescent current	N. W.	OM	40	80	mA
Vo	DC output voltage	VI.1.	$co_M$	6.95	Ī-	V
Mute/standby	y switch	OM.TW WW.1003	1001	1.1.	•	_
V <sub>8</sub>	switch-on voltage level	see Fig.5	8.5	4.17	_	V
Mute condition	on IV	OW.TW WWW.10	07.	M.T	N	•
Vo V.Co	output signal in mute position	$V_{I(max)} = 1 \text{ V; } f_i = 20 \text{ Hz to } 15 \text{ kHz}$	06 X.C	-w.1	2	mV
Standby con	dition	Y.COMITH WWW	100Y.	M	TW	•
I <sub>sb</sub>	DC current in standby condition	W.CO. TWI WWW	700¥	CO	100	μΑ
$V_{sw}$	switch-on current	W.COM. WWW	- 00	12	40	μΑ
V <sub>sw</sub> Note	switch-on current	ON.CO.TH WW.	N.100	12	40	μΑ

1. The circuit is DC adjusted at  $V_P = 6$  to 18 V and AC operating at  $V_P = 8.5$  to 18 V. WWW.100Y.COM.TW WWW.100Y.COM

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## 2 x 6 W stereo power amplifier

TDA1517; TDA1517P

#### **AC CHARACTERISTICS**

 $V_P = 14.4 \text{ V}$ ;  $R_L = 4 \Omega$ ; f = 1 kHz;  $T_{amb} = 25 \,^{\circ}\text{C}$ ; measured in Fig.6; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Po	output power	THD = 0.5%; note 1	4	5	_	W
	W. 100 r. COM.	THD = 10%; note 1	5.5	6.0	N -	W
THD	total harmonic distortion	P <sub>o</sub> = 1 W	1,100	0.1	- ST	%
f <sub>ir</sub>	low frequency roll-off	at -3 dB; note 2	W-100 Y	45		Hz
f <sub>hr</sub>	high frequency roll-off	at -1 dB	20		17	kHz
G <sub>v</sub>	closed loop voltage gain	W WY	19	20	21	dB
SVRR COM	supply voltage ripple rejection on mute standby	note 3	48 48 80	07.CO	MITW MATW	dB dB dB
Z <sub>i</sub>	input impedance	Y.Co. III	50	60	75	kΩ
V <sub>no</sub> C NW 100Y C WWW 100Y	noise output voltage on on mute	$R_s = 0 \Omega$ ; note 4 $R_s = 10 \Omega$ ; note 4 note 5	- MA - MA	50 70 50	- 100 -	μV μV μV
$\alpha_{cs}$	channel separation	$R_s = 10 \Omega$	40	- 2017	00.	dB
ΔG <sub>v</sub>	channel unbalance	1001.COMITY	_	0.1	01	dB

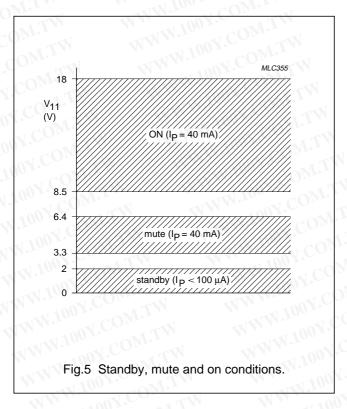
#### Notes

- 1. Output power is measured directly at the output pins of the IC.
- 2. Frequency response externally fixed.
- 3. Ripple rejection measured at the output with a source impedance of 0  $\Omega$ , maximum ripple amplitude of 2 V (p-p) and a frequency between 100 Hz and 10 kHz.
- 4. Noise voltage measured in a bandwidth of 20 Hz to 20 kHz.
- 5. Noise output voltage independent of  $R_s$  ( $V_I = 0 V$ ).

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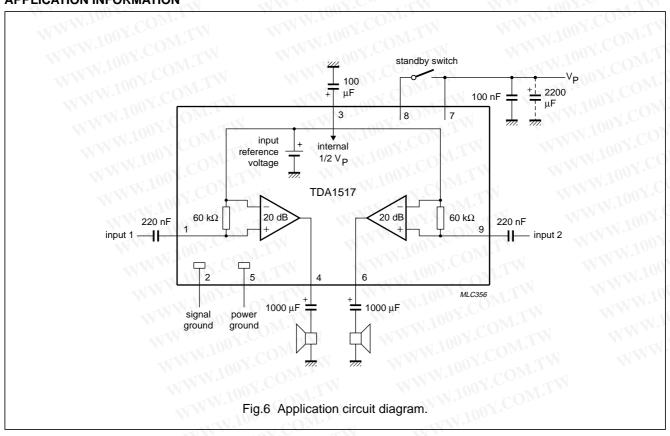
## 2 x 6 W stereo power amplifier

## TDA1517; TDA1517P



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#### **APPLICATION INFORMATION**



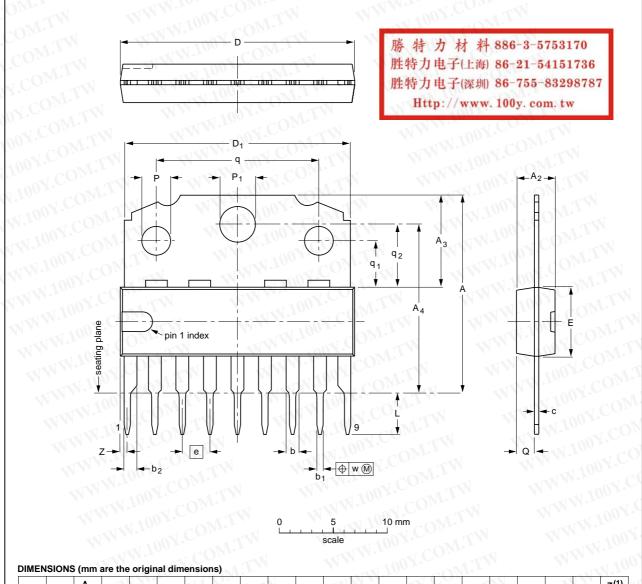
## 2 x 6 W stereo power amplifier

## TDA1517; TDA1517P

#### **PACKAGE OUTLINES**

#### SIL9MPF: plastic single in-line medium power package with fin; 9 leads

SOT110-1



UNIT	Α	A <sub>2</sub> max.	A <sub>3</sub>	A <sub>4</sub>	b	b <sub>1</sub>	b <sub>2</sub>	C	D <sup>(1)</sup>	D <sub>1</sub>	E <sup>(1)</sup>	е	N.40	OP ·	P <sub>1</sub>	Q	q	q <sub>1</sub>	q <sub>2</sub>	w	Z <sup>(1)</sup> max.
mm	18.5 17.8	3.7	8.7 8.0	15.8 15.4	1.40 1.14	0.67 0.50	1.40 1.14	0.48 0.38	21.8 21.4	21.4 20.7	6.48 6.20	2.54	3.9 3.4	2.75 2.50	3.4 3.2	1.75 1.55	15.1 14.9	4.4 4.2	5.9 5.7	0.25	N <sup>1</sup> N

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE	MA	REFE	W 100	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	MM	PROJECTION	ISSUE DATE
SOT110-1	WWW	V.100Y.CO	VIIV	WWW.		95-02-25 03-03-12

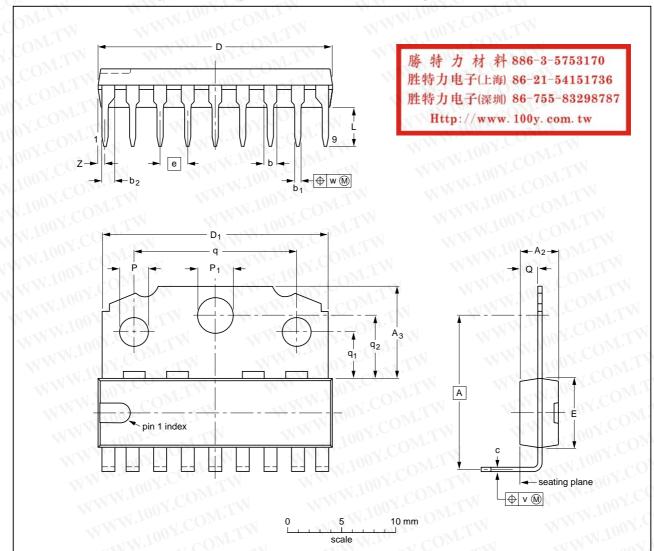
## 2 x 6 W stereo power amplifier

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## TDA1517; TDA1517P

#### RBS9MPF: plastic rectangular-bent single in-line medium power package with fin; 9 leads

SOT352-1



#### DIMENSIONS (mm are the original dimensions)

UNIT	A <sup>(1)</sup>	A <sub>2</sub> max.	A <sub>3</sub>	b.	b <sub>1</sub>	b <sub>2</sub>	C	D <sup>(2)</sup>	D <sub>1</sub>	E (2)	е	L	.1p	P <sub>1</sub>	Q	q	<b>q</b> 1	q <sub>2</sub>	v	w	Z <sup>(2)</sup> max.
mm	14.45	27	8.7	1.40	0.67	1.40	0.48	21.8	21.4	6.48	2.54	3.8	2.75	3.4	1.75	15.1	4.4	5.9	0.6	0.25	1
1111111	13.95	3.7	8.0	1.14	0.50	1.14	0.38	21.4	20.7	6.20	2.54	3.3	2.50	3.2	1.55	14.9	4.2	5.7	0.6	0.25	l '

#### Notes

- 1. Dimension is specified at seating plane.
- 2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

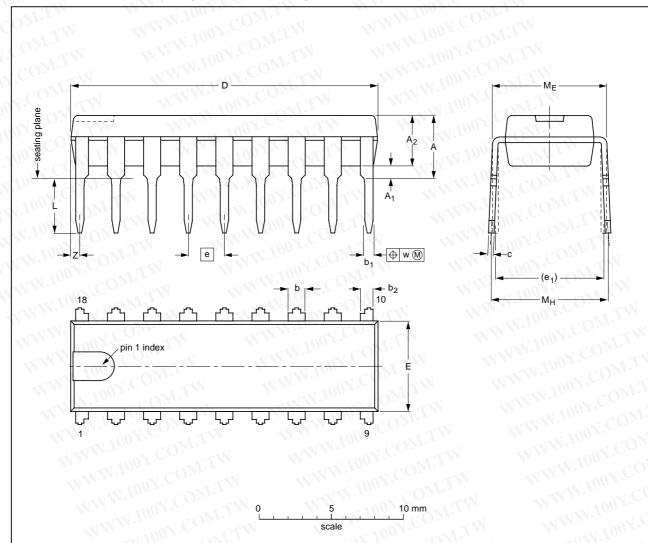
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VERSION	IEC	JEDEC	JEITA	MM	PROJECTION	ISSUE DATE
SOT352-1	WW	N.TOON.CO	VIIV	WWW		<del>97-12-16</del> 03-03-12

## 2 x 6 W stereo power amplifier

## TDA1517; TDA1517P

HDIP18: plastic heat-dissipating dual in-line package; 18 leads

SOT398-1



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	<b>b</b> .	b <sub>1</sub>	b <sub>2</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	T.A	ME	Мн	w	Z <sup>(1)</sup> max.
mm	4.7	0.51	3.7	1.40 1.14	0.67 0.50	1.05 0.75	0.47 0.38	21.85 21.35	6.5 6.2	2.54	7.62	3.9 3.1	8.32 8.02	8.7 7.7	0.25	1
inches	0.19	0.02	0.15	0.06 0.04	0.03 0.02	0.04 0.03	0.02 0.01	0.87 0.84	0.26 0.24	0.1	0.3	0.15 0.12	0.33 0.32	0.34 0.30	0.01	0.04

#### Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN	ISSUE DATE
	IEC	JEDEC	JEITA	11/11/11/10	PROJECTION	ISSUE DATE
SOT398-1	MM	N. 100 Y.CO	TIV	WWW.I		<del>95-01-25</del> 03-02-13

### 2 x 6 W stereo power amplifier

## TDA1517; TDA1517P

#### SOLDERING

## Introduction to soldering through-hole mount packages

This text gives a brief insight to wave, dip and manual soldering. A more in-depth account of soldering ICs can be found in our "Data Handbook IC26; Integrated Circuit Packages" (document order number 9398 652 90011).

Wave soldering is the preferred method for mounting of through-hole mount IC packages on a printed-circuit board.

#### Soldering by dipping or by solder wave

Driven by legislation and environmental forces the worldwide use of lead-free solder pastes is increasing. Typical dwell time of the leads in the wave ranges from 3 to 4 seconds at 250 °C or 265 °C, depending on solder material applied, SnPb or Pb-free respectively.

The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ( $T_{stg(max)}$ ). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

#### Manual soldering

Apply the soldering iron (24 V or less) to the lead(s) of the package, either below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

#### Suitability of through-hole mount IC packages for dipping and wave soldering methods

PACKAGE	SOLDERING METHOD			
PACKAGE	DIPPING	WAVE		
CPGA, HCPGA	- MANTON COM.	suitable		
DBS, DIP, HDIP, RDBS, SDIP, SIL	suitable	suitable <sup>(1)</sup>		
PMFP <sup>(2)</sup>	- 111001.00	not suitable		

#### **Notes**

- 1. For SDIP packages, the longitudinal axis must be parallel to the transport direction of the printed-circuit board.
- 2. For PMFP packages hot bar soldering or manual soldering is suitable.

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## 2 x 6 W stereo power amplifier

TDA1517; TDA1517P

#### **DATA SHEET STATUS**

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS(2)(3)	DEFINITION
rco <sub>M</sub>	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
100X·CO	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
M.100 M.100 A	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

#### **Notes**

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

#### **DEFINITIONS**

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

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